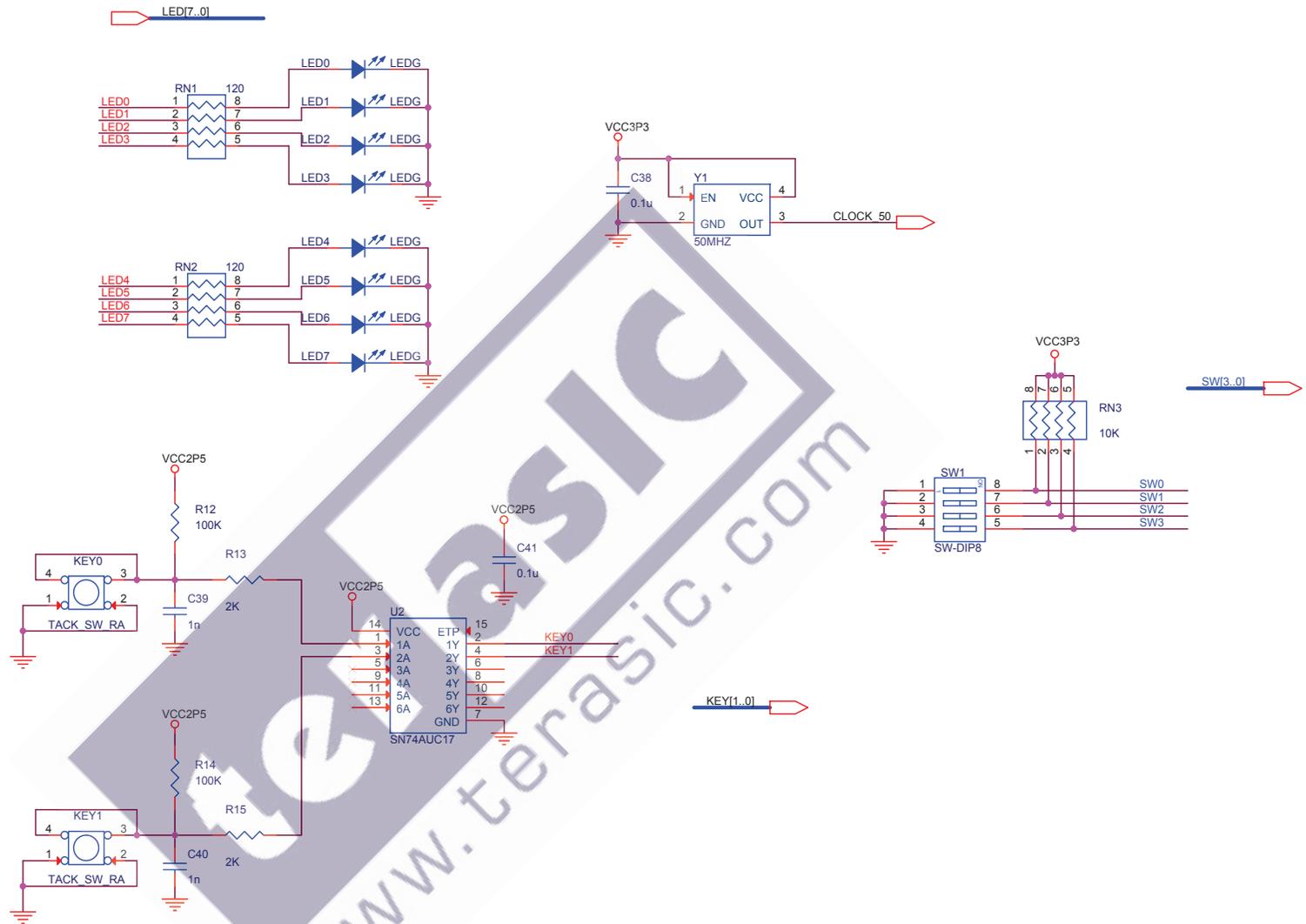
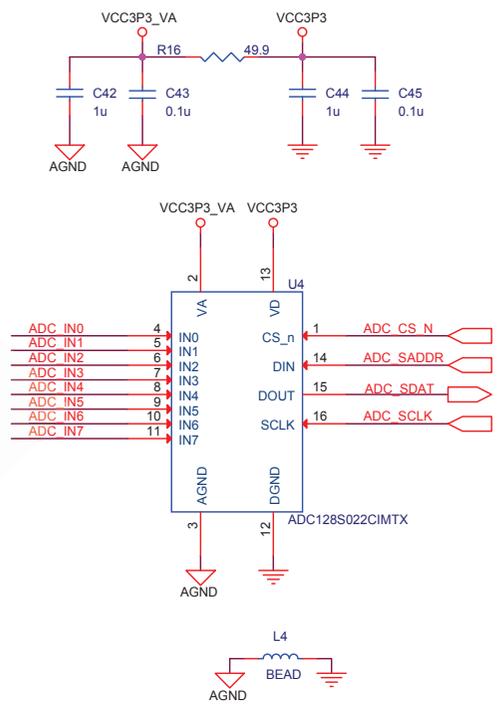
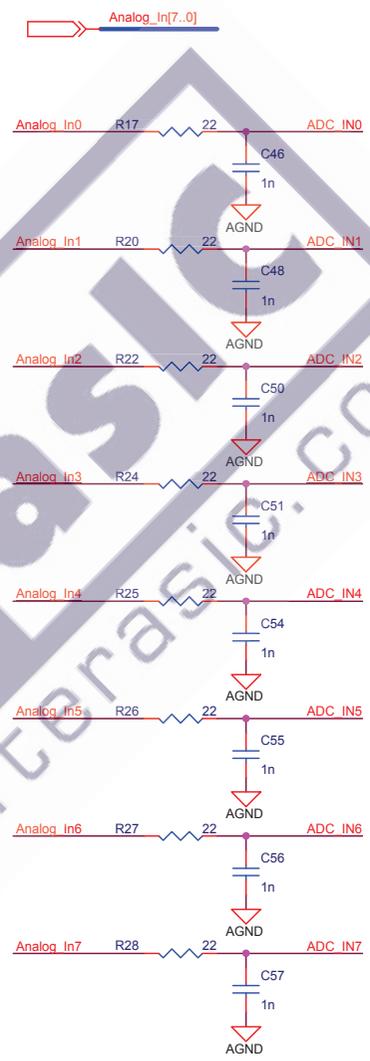
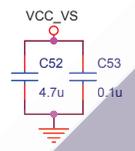
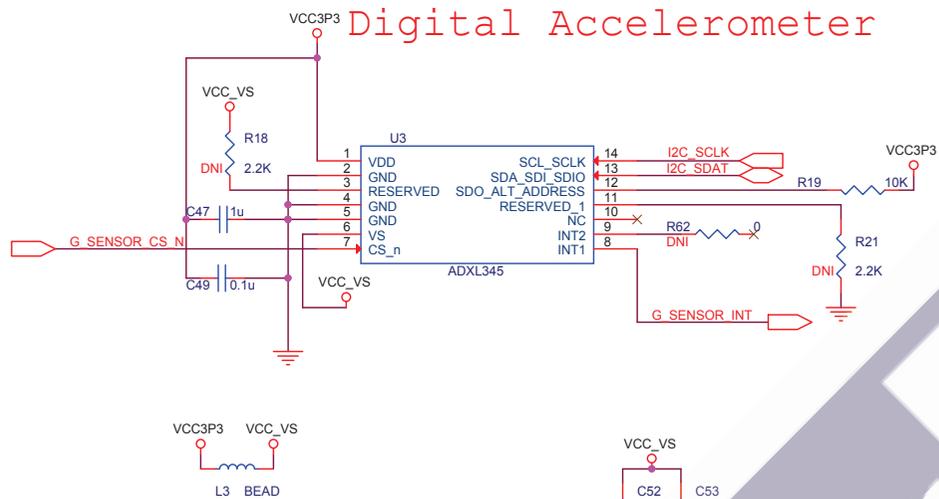


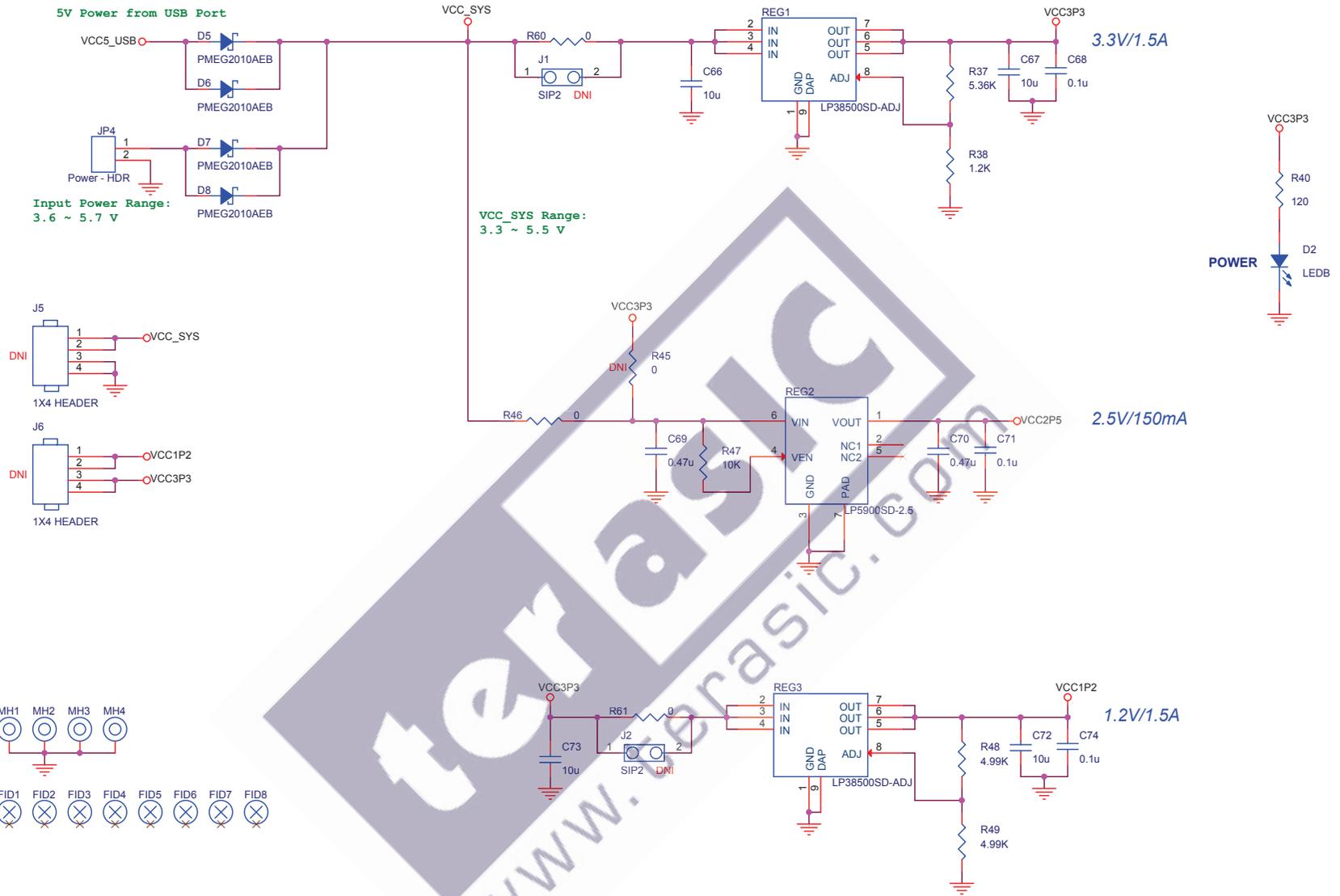
PMP10580



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B	CLOCK & LED & BUTTON & SWITCH	C
Date:	Thursday, July 12, 2012	Sheet 9 of 14



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B	1.2V & 2.5V & 3.3V	C
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